

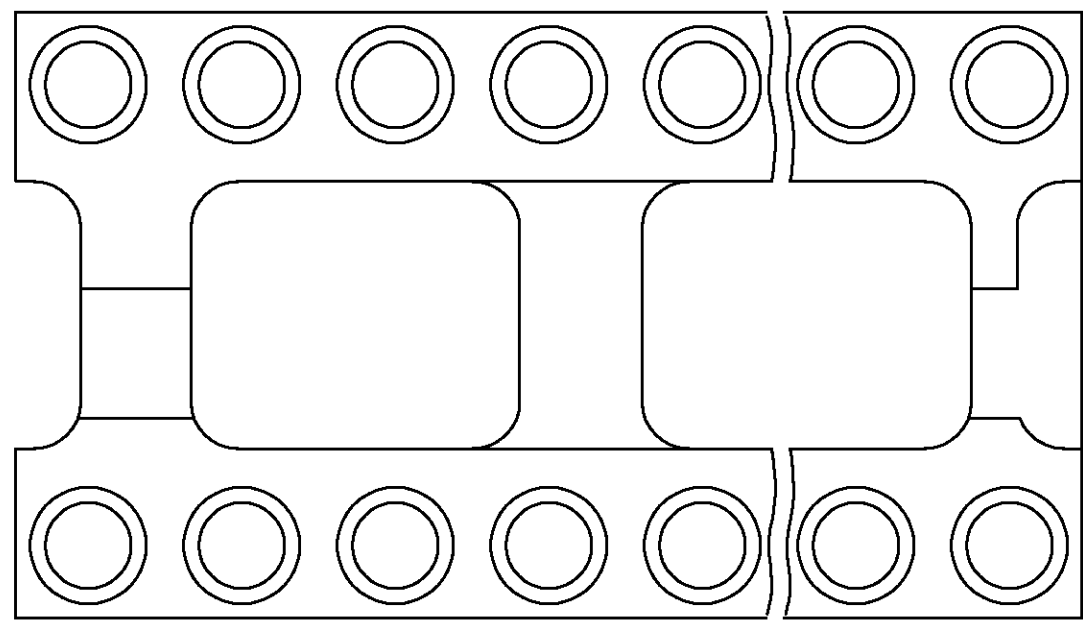


FIG. 1

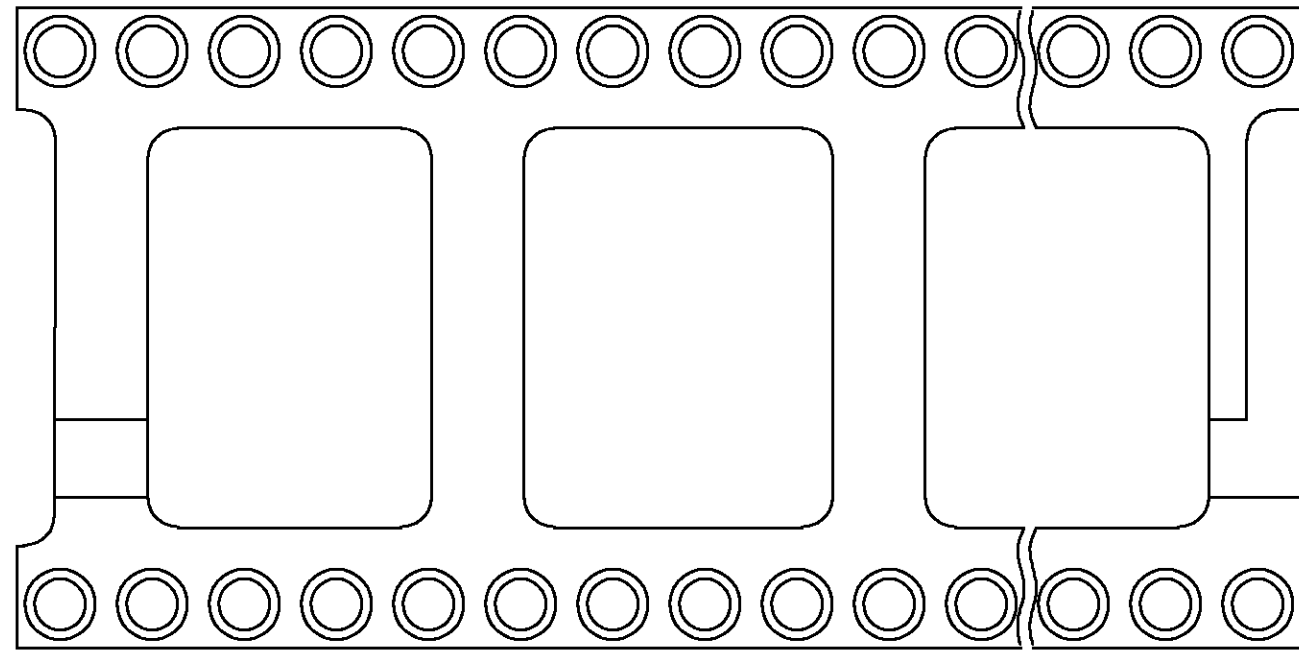


FIG. 2

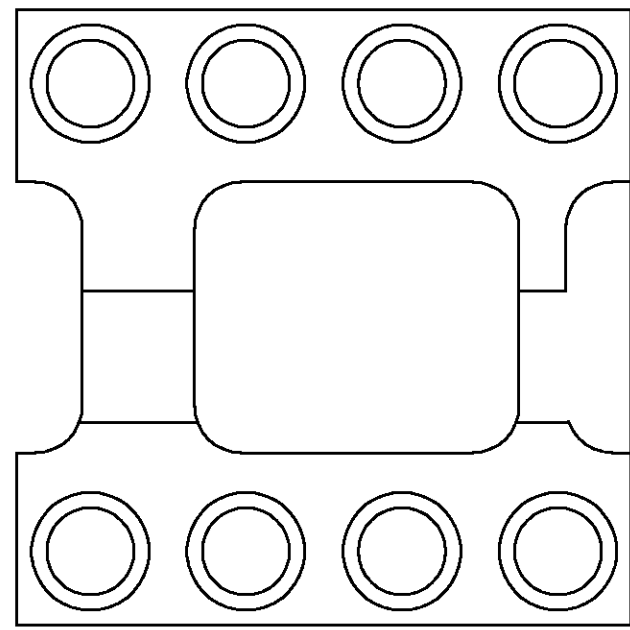


FIG. 3
(8 POS ONLY)

MATERIALS:
INSULATOR: POLYESTER, UL RATED 94V-0
CONTACT:
800 & 1800 SERIES CONTACT: 4 BEAM, COPPER ALLOY, MACHINED (PREMIUM VERSION) OR FORMED (ECONOMY VERSION, WITH SUFFIX -ES OR -ESL).
800 SERIES HIGH RETENTION CONTACT: 4 BEAM, COPPER ALLOY, MACHINED.
1000 SERIES CONTACT: 6 BEAM, COPPER ALLOY, MACHINED (LOW INSERTION FORCE SERIES)
SLEEVE- ALL SERIES: COPPER ALLOY, FORMED

ELECTRICAL:
CONTACT RESISTANCE: 10 MILLIOHMS MAX
CONTACT RATING: 3 AMPS
CAPACITANCE: 1.0 pF PER MIL-STD-202, METHOD 305
INSULATION RESISTANCE: 5000 OHMS MIN @ 500 VDC PER MIL-STD-1344, METHOD 3003.1
DIELECTRIC WITHSTANDING VOLTAGE: 1000 VOLTS (RMS) PER MIL-STD-1344, METHOD 3001.1

MECHANICAL:
AFTER INSERTION FORCE: 37 GRAMS AVG (6 BEAM CONTACT) 134 GRAMS AVG (4 BEAM PREMIUM) 179 GRAMS AVG (4 BEAM ECONOMY) AND 334 GRAMS AVG (HIGH RETENTION)
AFTER WITHDRAWAL FORCE: 15 GRAMS AVG (6 BEAM CONTACT) 63 GRAMS AVG (4 BEAM PREMIUM OR ECONOMY) AND 245 GRAMS AVG (HIGH RETENTION)

ENVIRONMENTAL:
OPERATING TEMPERATURE: -55°C TO -105°C

PLATING: 25μ" MIN GOLD OVER 50μ" MIN NICKEL CONTACT WITH 5μ" MIN GOLD OVER 50μ" MIN NICKEL SLEEVE.

PLATING: 25μ" MIN GOLD OVER 50μ" MIN NICKEL CONTACT WITH 80μ" MIN TIN-LEAD OVER 50μ" MIN COPPER SLEEVE.

PLATING: 80μ" MIN TIN-LEAD OVER 75μ" MIN COPPER CONTACT WITH 180μ" MIN TIN-LEAD OVER 75μ" MIN NICKEL SLEEVE.

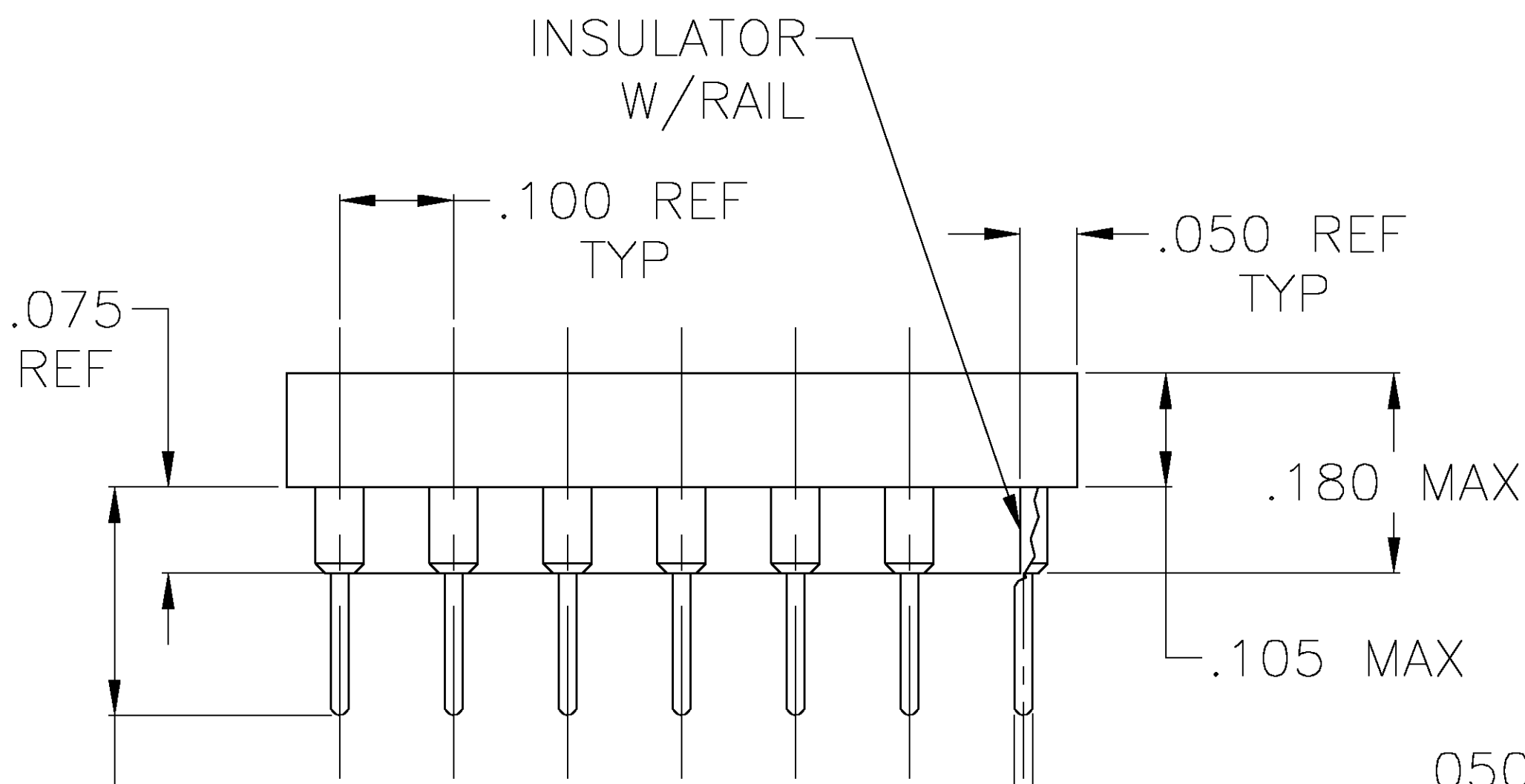
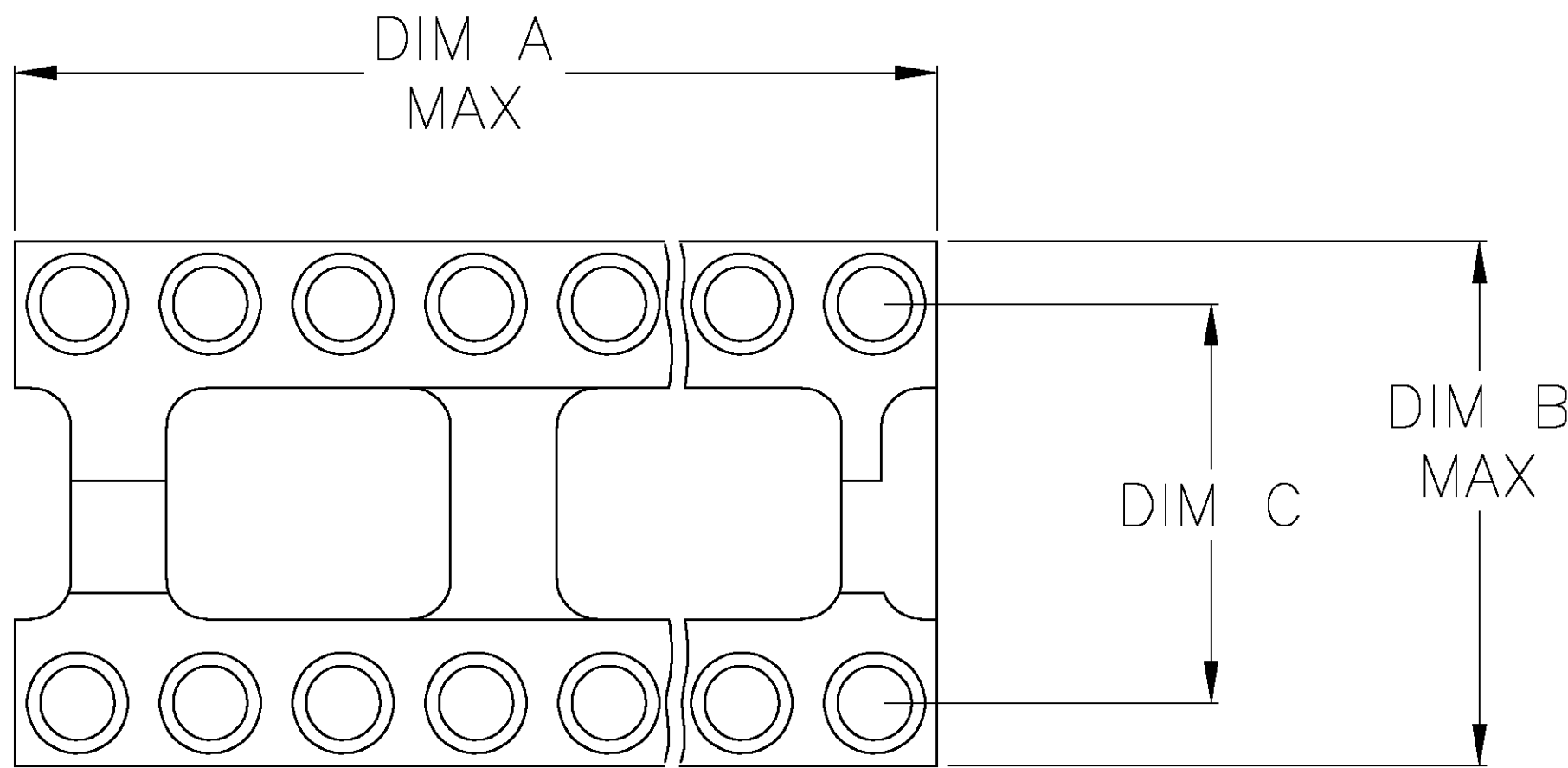
PLATING: 5μ" MIN GOLD FLASH OVER 50μ" MIN NICKEL CONTACT WITH 5μ" MIN GOLD FLASH OVER 50μ" MIN NICKEL SLEEVE.

PLATING: 5μ" MIN GOLD FLASH OVER 50μ" MIN NICKEL CONTACT WITH 80μ" MIN TIN-LEAD OVER 50μ" MIN COPPER SLEEVE.

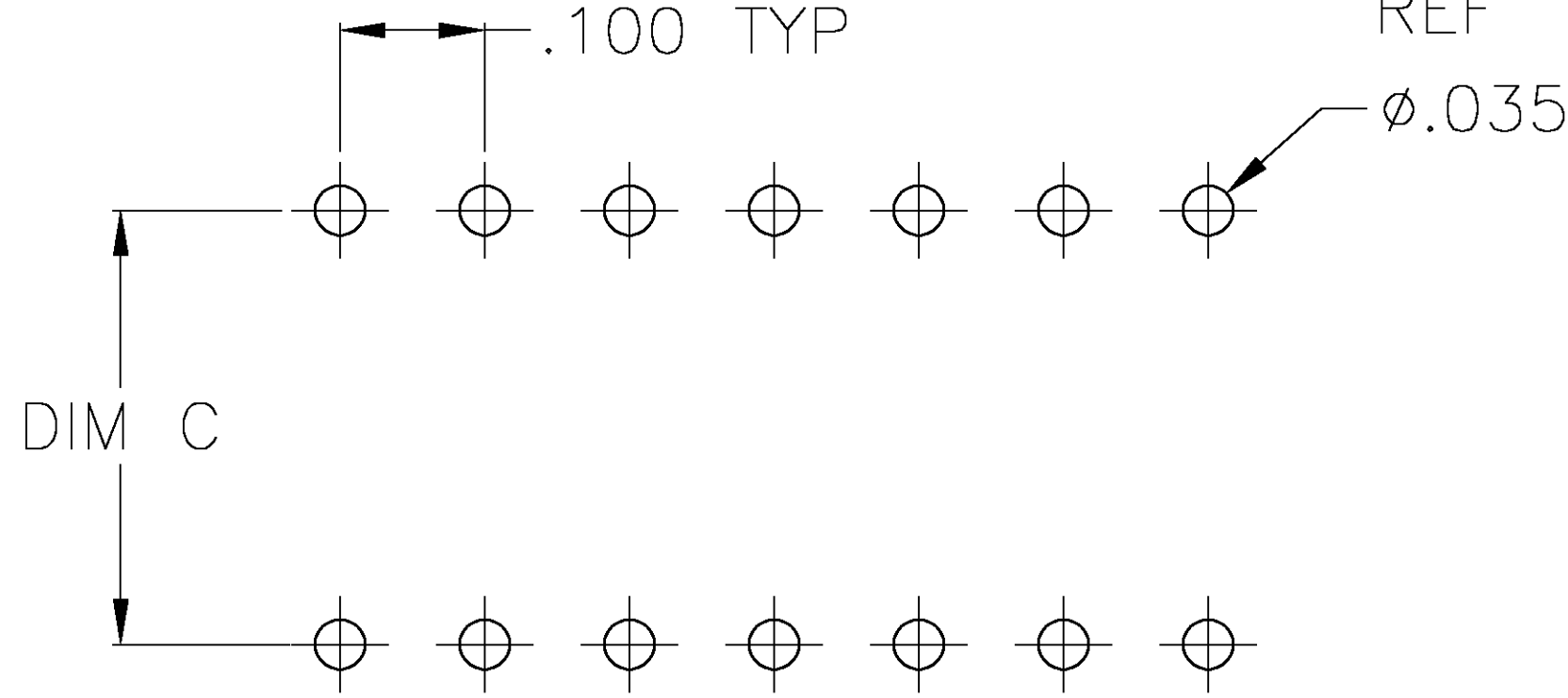
PLATING: 7.5μ" MIN GOLD OVER 50μ" MIN NICKEL CONTACT WITH 80μ" MIN TIN-LEAD OVER 50μ" MIN COPPER SLEEVE.

PRELIMINARY PART - NOT RELEASED FOR PRODUCTION.

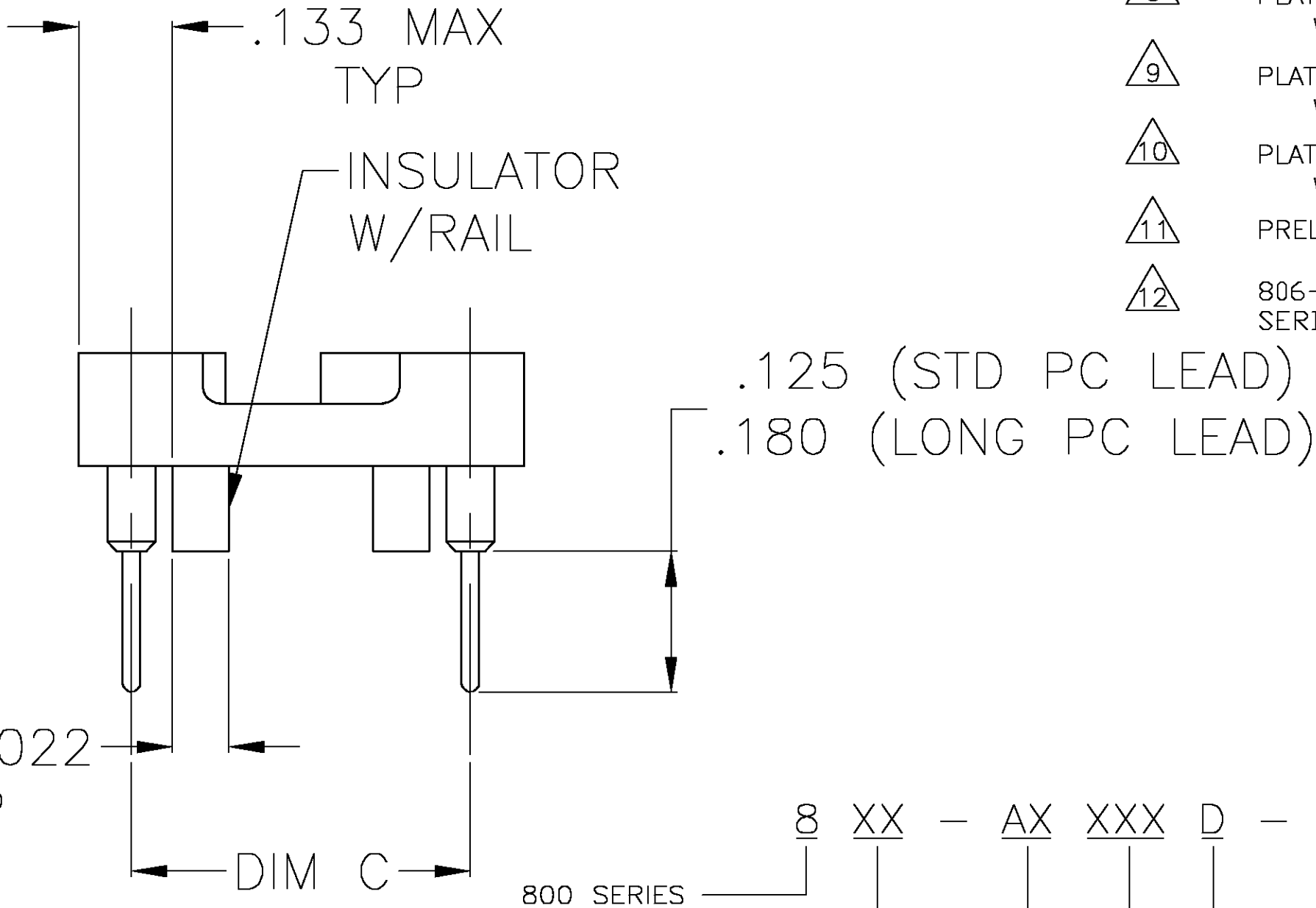
806-AGXXD-XXX SERIES IS SUPERSEDED BY 506-AGXXD-XXX SERIES (REFER TO CUSTOMER DRAWING 1437532-2)



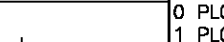
.210/.180
(STD .125 PC LEAD)
.265/.235
(LONG .180 PC LEAD)



P.C.B. HOLE LAYOUT
TOLERANCE ±.003



800 SERIES POSITIONS 8 XX - AX XXX D - XXX
BLANK = MACHINED CONTACT
ES = FORMED CONTACT, GOLD PLATE, NOTE 1
ESL = FORMED CONTACT, LOW GOLD PLATE, 5μIN MAX
D = PC TAIL STANDARD
LSG STYLE AND TAIL CONFIGURATION
AG = INSULATOR
AR = INSULATOR WITH RAILS
(ALMOST RUN THE LENGTH UNDER THE INSULATOR INSIDE THE CONTACT ROWS, .075 REF HIGH & .045 REF WIDE)

THIS DRAWING IS A CONTROLLED DOCUMENT.			DIN R BROWN 06MAY04		tyco Electronics		Tyco Electronics Corporation				
			CHK K WRIGHT 06MAY04				Harrisburg, Pa 17105-3608				
DIMENSIONS: INCHES		TOLERANCES, UNLESS OTHERWISE SPECIFIED:		APVD K WRIGHT 06MAY04		NAME		DIP SOCKET, 800 SERIES			
		0 PLC ± -		PRODUCT SPEC		SIZE CAGE CODE DRAWING NO				RESTRICTED TO	
		1 PLC ± -		APPLICATION SPEC							
		2 PLC ± -									
		3 PLC ± .005									
		4 PLC ± -				ANGLES ± -		WEIGHT		A1 00779 C=1437539-2	
FINISH				CUSTOMER DRAWING		SCALE 1:1		SHEET 1 of 4		REV A	

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